

# TLC0820AC, TLC0820AI

## Advanced LinCMOS™ HIGH-SPEED 8-BIT ANALOG-TO-DIGITAL CONVERTERS USING MODIFIED FLASH TECHNIQUES

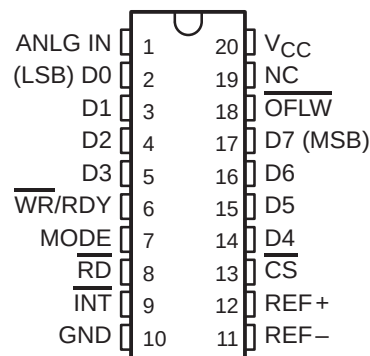
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- **Advanced LinCMOS™ Silicon-Gate Technology**
- **8-Bit Resolution**
- **Differential Reference Inputs**
- **Parallel Microprocessor Interface**
- **Conversion and Access Time Over Temperature Range**  
Read Mode . . . 2.5  $\mu$ s Max
- **No External Clock or Oscillator Components Required**
- **On-Chip Track and Hold**
- **Single 5-V Supply**
- **TLC0820A Is Direct Replacement for National Semiconductor ADC0820C/CC and Analog Devices AD7820K/B/T**

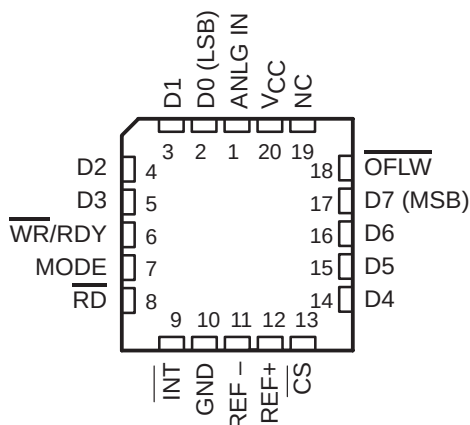
### description

The TLC0820AC and the TLC0820AI are Advanced LinCMOS™ 8-bit analog-to-digital converters each consisting of two 4-bit flash converters, a 4-bit digital-to-analog converter, a summing (error) amplifier, control logic, and a result latch circuit. The modified flash technique allows low-power integrated circuitry to complete an 8-bit conversion in 1.18  $\mu$ s over temperature. The on-chip track-and-hold circuit has a 100-ns sample window and allows these devices to convert continuous analog signals having slew rates of up to 100 mV/ $\mu$ s without external sampling components. TTL-compatible 3-state output drivers and two modes of operation allow interfacing to a variety of microprocessors. Detailed information on interfacing to most popular microprocessors is readily available from the factory.

**DB, DW, OR N PACKAGE  
(TOP VIEW)**



**FN PACKAGE  
(TOP VIEW)**



NC—No internal connection

### AVAILABLE OPTIONS

| T <sub>A</sub> | TOTAL UNADJUSTED ERROR | PACKAGE     |                            |                           |                 |
|----------------|------------------------|-------------|----------------------------|---------------------------|-----------------|
|                |                        | SSOP (DB)   | PLASTIC SMALL OUTLINE (DW) | PLASTIC CHIP CARRIER (FN) | PLASTIC DIP (N) |
| 0°C to 70°C    | ±1 LSB                 | TLC0820ACDB | TLC0820ACDW                | TLC0820ACFN               | TLC0820ACN      |
| –40°C to 85°C  | ±1 LSB                 | —           | TLC0820AIDW                | TLC0820AIFN               | TLC0820AIN      |

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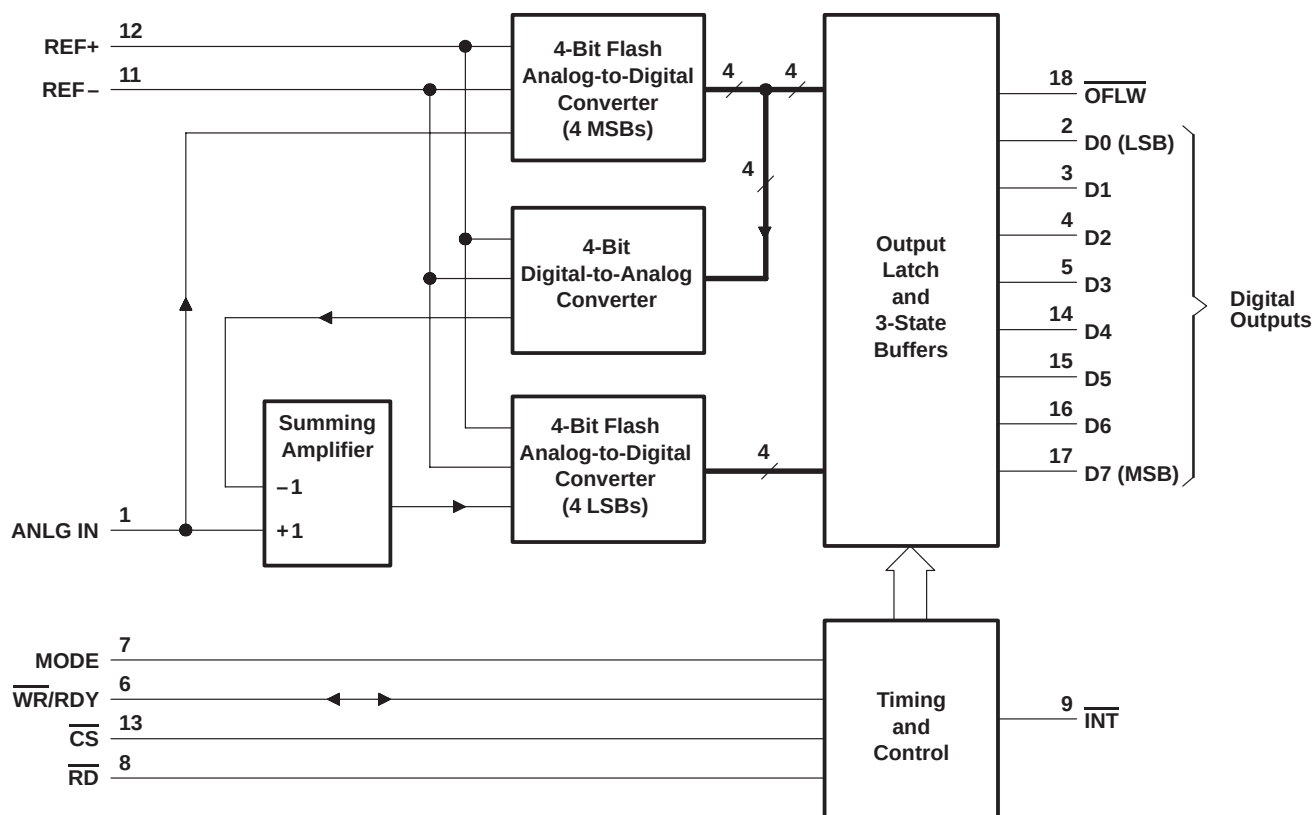
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### functional block diagram



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## Terminal Functions

| TERMINAL<br>NAME                  | NO. | I/O | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|-----------------------------------|-----|-----|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ANLG IN                           | 1   | I   | Analog input                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| $\overline{\text{CS}}$            | 13  | I   | Chip select. $\overline{\text{CS}}$ must be low in order for $\overline{\text{RD}}$ or $\overline{\text{WR}}$ to be recognized by the ADC.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| D0                                | 2   | O   | Digital, 3-state output data, bit 1 (LSB)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| D1                                | 3   | O   | Digital, 3-state output data, bit 2                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| D2                                | 4   | O   | Digital, 3-state output data, bit 3                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| D3                                | 5   | O   | Digital, 3-state output data, bit 4                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| D4                                | 14  | O   | Digital, 3-state output data, bit 5                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| D5                                | 15  | O   | Digital, 3-state output data, bit 6                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| D6                                | 16  | O   | Digital, 3-state output data, bit 7                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| D7                                | 17  | O   | Digital, 3-state output data, bit 8 (MSB)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| GND                               | 10  |     | Ground                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| $\overline{\text{INT}}$           | 9   | O   | Interrupt. In the write-read mode, the interrupt output ( $\overline{\text{INT}}$ ) going low indicates that the internal count-down delay time, $t_{d(\text{int})}$ , is complete and the data result is in the output latch. The delay time $t_{d(\text{int})}$ is typically 800 ns starting after the rising edge of $\overline{\text{WR}}$ (see operating characteristics and Figure 3). If $\overline{\text{RD}}$ goes low prior to the end of $t_{d(\text{int})}$ , $\overline{\text{INT}}$ goes low at the end of $t_{d(\text{RIL})}$ and the conversion results are available sooner (see Figure 2). $\overline{\text{INT}}$ is reset by the rising edge of either $\overline{\text{RD}}$ or $\overline{\text{CS}}$ .                                   |
| MODE                              | 7   | I   | Mode select. MODE is internally tied to GND through a 50- $\mu\text{A}$ current source, which acts like a pulldown resistor. When MODE is low, the read mode is selected. When MODE is high, the write-read mode is selected.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| NC                                | 19  |     | No internal connection                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| $\overline{\text{OFLW}}$          | 18  | O   | Overflow. Normally $\overline{\text{OFLW}}$ is a logical high. However, if the analog input is higher than $V_{\text{ref+}}$ , $\overline{\text{OFLW}}$ will be low at the end of conversion. It can be used to cascade two or more devices to improve resolution (9 or 10 bits).                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| $\overline{\text{RD}}$            | 8   | I   | Read. In the write-read mode with $\overline{\text{CS}}$ low, the 3-state data outputs D0 through D7 are activated when $\overline{\text{RD}}$ goes low. $\overline{\text{RD}}$ can also be used to increase the conversion speed by reading data prior to the end of the internal count-down delay time. As a result, the data transferred to the output latch is latched after the falling edge of $\overline{\text{RD}}$ . In the read mode with $\overline{\text{CS}}$ low, the conversion starts with $\overline{\text{RD}}$ going low. $\overline{\text{RD}}$ also enables the 3-state data outputs on completion of the conversion. RDY going into the high-impedance state and $\overline{\text{INT}}$ going low indicate completion of the conversion. |
| REF–                              | 11  | I   | Reference voltage. REF– is placed on the bottom of the resistor ladder.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| REF+                              | 12  | I   | Reference voltage. REF+ is placed on the top of the resistor ladder.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| $V_{\text{CC}}$                   | 20  |     | Power supply voltage                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| $\overline{\text{WR}}/\text{RDY}$ | 6   | I/O | Write ready. In the write-read mode with $\overline{\text{CS}}$ low, the conversion is started on the falling edge of the $\overline{\text{WR}}$ input signal. The result of the conversion is strobed into the output latch after the internal count-down delay time, $t_{d(\text{int})}$ , provided that the $\overline{\text{RD}}$ input does not go low prior to this time. The delay time $t_{d(\text{int})}$ is approximately 800 ns. In the read mode, RDY (an open-drain output) goes low after the falling edge of $\overline{\text{CS}}$ and goes into the high-impedance state when the conversion is strobed into the output latch. It is used to simplify the interface to a microprocessor system.                                                |



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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|                                                                                   |                          |
|-----------------------------------------------------------------------------------|--------------------------|
| Supply voltage, $V_{CC}$ (see Note 1)                                             | 10 V                     |
| Input voltage range, all inputs (see Note 1)                                      | –0.2 V to $V_{CC}+0.2$ V |
| Output voltage range, all outputs (see Note 1)                                    | –0.2 V to $V_{CC}+0.2$ V |
| Operating free-air temperature range: TLC0820AC                                   | 0°C to 70°C              |
| TLC0820AI                                                                         | –40°C to 85°C            |
| Storage temperature range                                                         | –65°C to 150°C           |
| Case temperature for 10 seconds: FN package                                       | 260°C                    |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: DB, DW or N package | 260°C                    |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltages are with respect to network GND.

### recommended operating conditions

|                                                                                       |                                    |                                                   | MIN                | NOM | MAX                  | UNIT |
|---------------------------------------------------------------------------------------|------------------------------------|---------------------------------------------------|--------------------|-----|----------------------|------|
| Supply voltage, V <sub>CC</sub>                                                       |                                    |                                                   | 4.5                | 5   | 8                    | V    |
| Analog input voltage                                                                  |                                    |                                                   | −0.1               |     | V <sub>CC</sub> +0.1 | V    |
| Positive reference voltage, V <sub>ref</sub> +                                        |                                    |                                                   | V <sub>ref</sub> − |     | V <sub>CC</sub>      | V    |
| Negative reference voltage, V <sub>ref</sub> −                                        |                                    |                                                   | GND                |     | V <sub>ref</sub> +   | V    |
| High-level input voltage, V <sub>IH</sub>                                             | V <sub>CC</sub> = 4.75 V to 5.25 V | $\overline{CS}, \overline{WR/RDY}, \overline{RD}$ | 2                  |     |                      | V    |
|                                                                                       |                                    | MODE                                              | 3.5                |     |                      |      |
| Low-level input voltage, V <sub>IL</sub>                                              | V <sub>CC</sub> = 4.75 V to 5.25 V | $\overline{CS}, \overline{WR/RDY}, \overline{RD}$ |                    |     | 0.8                  | V    |
|                                                                                       |                                    | MODE                                              |                    |     | 1.5                  |      |
| Pulse duration, write in write-read mode, t <sub>w(W)</sub> (see Figures 2, 3, and 4) |                                    |                                                   | 0.5                |     | 50                   | μs   |
| Operating free-air temperature, T <sub>A</sub>                                        | TLC0820AC                          |                                                   | 0                  |     | 70                   | °C   |
|                                                                                       | TLC0820AI                          |                                                   | −40                |     | 85                   |      |



TLC0820AC, TLC0820AI

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**electrical characteristics at specified operating free-air temperature,  $V_{CC} = 5\text{ V}$  (unless otherwise noted)**

| PARAMETER        |                                                 |                                                                                           | TEST CONDITIONS                                                                         | T <sub>A</sub> <sup>†</sup> | MIN        | TYP    | MAX  | UNIT |
|------------------|-------------------------------------------------|-------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------|-----------------------------|------------|--------|------|------|
| V <sub>OH</sub>  | High-level output voltage                       | D0–D7, $\overline{\text{INT}}$ , or $\overline{\text{OFLW}}$                              | V <sub>CC</sub> = 4.75 V, I <sub>OH</sub> = –360 μA                                     | Full range                  | 2.4        |        |      | V    |
|                  |                                                 |                                                                                           | V <sub>CC</sub> = 4.75 V, I <sub>OH</sub> = –10 μA                                      | Full range                  | 4.5        |        |      |      |
|                  |                                                 |                                                                                           |                                                                                         | 25°C                        | 4.6        |        |      |      |
| V <sub>OL</sub>  | Low-level output voltage                        | D0–D7, $\overline{\text{OFLW}}$ , $\overline{\text{INT}}$ , or $\overline{\text{WR/RDY}}$ | V <sub>CC</sub> = 5.25 V, I <sub>OL</sub> = 1.6 mA                                      | Full range                  |            |        | 0.4  | V    |
|                  |                                                 |                                                                                           |                                                                                         | 25°C                        |            |        | 0.34 |      |
| I <sub>IH</sub>  | High-level input current                        | $\overline{\text{CS}}$ or $\overline{\text{RD}}$                                          | V <sub>IH</sub> = 5 V                                                                   | Full range                  |            | 0.005  | 1    | μA   |
|                  |                                                 | $\overline{\text{WR/RDY}}$                                                                |                                                                                         | Full range                  |            |        | 3    |      |
|                  |                                                 |                                                                                           |                                                                                         | 25°C                        |            | 0.1    | 0.3  |      |
|                  |                                                 |                                                                                           |                                                                                         | MODE                        | Full range |        |      |      |
| I <sub>IL</sub>  | Low-level input current                         | $\overline{\text{CS}}$ , $\overline{\text{WR/RDY}}$ , $\overline{\text{RD}}$ , or MODE    | V <sub>IL</sub> = 0                                                                     | Full range                  |            | –0.005 | –1   | μA   |
|                  |                                                 |                                                                                           |                                                                                         | 25°C                        |            |        |      |      |
| I <sub>OZ</sub>  | Off-state (high-impedance-state) output current | D0–D7 or $\overline{\text{WR/RDY}}$                                                       | V <sub>O</sub> = 5 V                                                                    | Full range                  |            |        | 3    | μA   |
|                  |                                                 |                                                                                           |                                                                                         | 25°C                        |            | 0.1    | 0.3  |      |
|                  |                                                 |                                                                                           | V <sub>O</sub> = 0                                                                      | Full range                  |            |        | –3   |      |
|                  |                                                 |                                                                                           |                                                                                         | 25°C                        |            | –0.1   | –0.3 |      |
| I <sub>I</sub>   | Analog input current                            |                                                                                           | CS at 5 V, V <sub>I</sub> = 5 V                                                         | Full range                  |            |        | 3    | μA   |
|                  |                                                 |                                                                                           |                                                                                         | 25°C                        |            |        | 0.3  |      |
|                  |                                                 |                                                                                           | CS at 5 V, V <sub>I</sub> = 0                                                           | Full range                  |            |        | –3   |      |
|                  |                                                 |                                                                                           |                                                                                         | 25°C                        |            |        | –0.3 |      |
| I <sub>OS</sub>  | Short-circuit output current                    | D0–D7, $\overline{\text{OFLW}}$ , $\overline{\text{INT}}$ , or $\overline{\text{WR/RDY}}$ | V <sub>O</sub> = 5 V                                                                    | Full range                  | 7          |        |      | mA   |
|                  |                                                 |                                                                                           |                                                                                         | 25°C                        | 8.4        | 14     |      |      |
|                  |                                                 | D0–D7 or $\overline{\text{OFLW}}$                                                         | V <sub>O</sub> = 0                                                                      | Full range                  | –6         |        |      |      |
|                  |                                                 |                                                                                           |                                                                                         | 25°C                        | –7.2       | –12    |      |      |
|                  |                                                 | INT                                                                                       |                                                                                         | Full range                  | –4.5       |        |      |      |
|                  |                                                 |                                                                                           |                                                                                         | 25°C                        | –5.3       | –9     |      |      |
| R <sub>ref</sub> | Reference resistance                            |                                                                                           |                                                                                         | Full range                  | 1.25       |        | 6    | kΩ   |
|                  |                                                 |                                                                                           |                                                                                         | 25°C                        | 1.4        | 2.3    | 5.3  |      |
| I <sub>CC</sub>  | Supply current                                  |                                                                                           | $\overline{\text{CS}}$ , $\overline{\text{WR/RDY}}$ , and $\overline{\text{RD}}$ at 0 V | Full range                  |            |        | 15   | mA   |
|                  |                                                 |                                                                                           |                                                                                         | 25°C                        |            | 7.5    | 13   |      |
| C <sub>i</sub>   | Input capacitance                               | D0–D7                                                                                     |                                                                                         | Full range                  |            | 5      |      | pF   |
|                  |                                                 | ANLG IN                                                                                   |                                                                                         |                             |            | 45     |      |      |
| C <sub>O</sub>   | Output capacitance                              | D0–D7                                                                                     |                                                                                         | Full range                  |            |        | 5    | pF   |

<sup>†</sup> Full range is as specified in recommended operating conditions.

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**operating characteristics,  $V_{CC} = 5\text{ V}$ ,  $V_{ref+} = 5\text{ V}$ ,  $V_{ref-} = 0$ ,  $t_r = t_f = 20\text{ ns}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)**

| PARAMETER     |                                                                                         | TEST CONDITIONS†                                                                | MIN                   | TYP                | MAX                | UNIT                   |
|---------------|-----------------------------------------------------------------------------------------|---------------------------------------------------------------------------------|-----------------------|--------------------|--------------------|------------------------|
| $k_{SVS}$     | Supply-voltage sensitivity                                                              | $V_{CC} = 5\text{ V} \pm 5\%$ , $T_A = \text{MIN to MAX}$                       |                       | $\pm 1/16$         | $\pm 1/4$          | LSB                    |
|               | Total unadjusted error‡                                                                 | MODE at 0 V, $T_A = \text{MIN to MAX}$                                          |                       |                    | 1                  | LSB                    |
| $t_{conv(R)}$ | Conversion time, read mode                                                              | MODE at 0 V, See Figure 1                                                       |                       | 1.6                | 2.5                | $\mu\text{s}$          |
| $t_{a(R)}$    | Access time, $\overline{RD}\downarrow$ to data valid                                    | MODE at 0 V, See Figure 1                                                       |                       | $t_{conv(R)} + 20$ | $t_{conv(R)} + 50$ | ns                     |
| $t_{a(R1)}$   | Access time, $\overline{RD}\downarrow$ to data valid                                    | MODE at 5 V,<br>$t_d(WR) < t_d(int)$ ,<br>See Figure 2                          | $C_L = 15\text{ pF}$  | 190                | 280                | ns                     |
|               |                                                                                         |                                                                                 | $C_L = 100\text{ pF}$ | 210                | 320                |                        |
| $t_{a(R2)}$   | Access time, $\overline{RD}\downarrow$ to data valid                                    | MODE at 5 V,<br>$t_d(WR) > t_d(int)$ ,<br>See Figure 3                          | $C_L = 15\text{ pF}$  | 70                 | 120                | ns                     |
|               |                                                                                         |                                                                                 | $C_L = 100\text{ pF}$ | 90                 | 150                |                        |
| $t_{a(INT)}$  | Access time, $\overline{INT}\downarrow$ to data valid                                   | MODE at 5 V, See Figure 4                                                       |                       | 20                 | 50                 | ns                     |
| $t_{dis}$     | Disable time, $\overline{RD}\uparrow$ to data valid                                     | $R_L = 1\text{ k}\Omega$ , $C_L = 10\text{ pF}$ ,<br>See Figures 1, 2, 3, and 5 |                       | 70                 | 95                 | ns                     |
| $t_{d(int)}$  | Delay time, $WR/RDY\uparrow$ to $INT\downarrow$                                         | MODE at 5 V, $C_L = 50\text{ pF}$ ,<br>See Figures 2, 3, and 4                  |                       | 800                | 1300               | ns                     |
| $t_{d(NC)}$   | Delay time, to next conversion                                                          | See Figures 1, 2, 3, and 4                                                      | 500                   |                    |                    | ns                     |
| $t_{d(WR)}$   | Delay time, $\overline{WR}/RDY\uparrow$ to $\overline{RD}\downarrow$ in write-read mode | See Figure 2                                                                    | 0.4                   |                    |                    | $\mu\text{s}$          |
| $t_{d(RDY)}$  | Delay time, $CS\downarrow$ to $WR/RDY\downarrow$                                        | MODE at 0 V, $C_L = 50\text{ pF}$ ,<br>See Figure 1                             |                       | 50                 | 100                | ns                     |
| $t_{d(RIH)}$  | Delay time, $\overline{RD}\uparrow$ to $\overline{INT}\uparrow$                         | $C_L = 50\text{ pF}$ , See Figures 1, 2, and 3                                  |                       | 125                | 225                | ns                     |
| $t_{d(RIL)}$  | Delay time, $RD\downarrow$ to $INT\downarrow$                                           | MODE at 5 V, $t_d(WR) < t_d(int)$ ,<br>See Figure 2                             |                       | 200                | 290                | ns                     |
| $t_{d(WIH)}$  | Delay time, $\overline{WR}/RDY\uparrow$ to $\overline{INT}\uparrow$                     | MODE at 5 V, $C_L = 50\text{ pF}$ ,<br>See Figure 4                             |                       | 175                | 270                | ns                     |
|               | Slew-rate tracking                                                                      |                                                                                 |                       | 0.1                |                    | $\text{V}/\mu\text{s}$ |

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ Total unadjusted error includes offset, full-scale, and linearity errors.

### PARAMETER MEASUREMENT INFORMATION

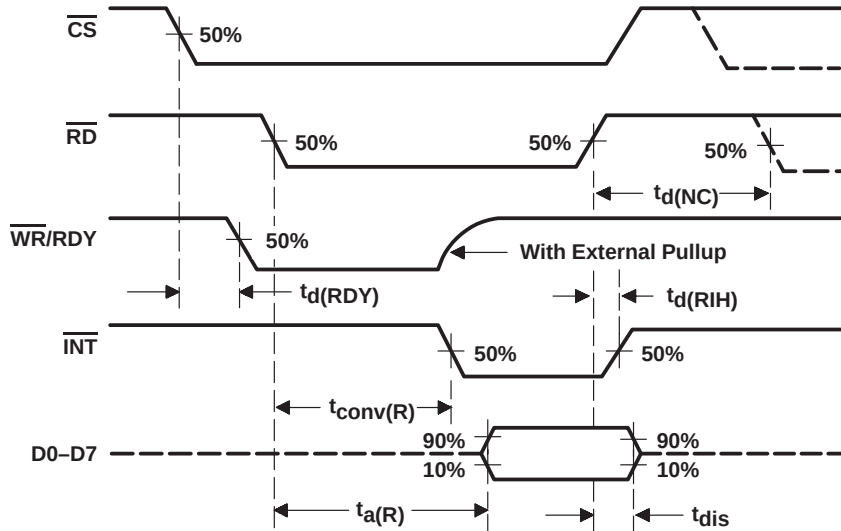


Figure 1. Read-Mode Waveforms (MODE Low)

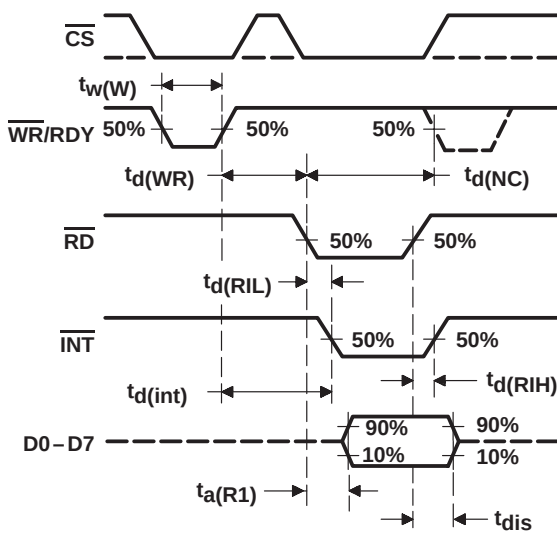


Figure 2. Write-Read-Mode Waveforms  
[MODE High and  $t_d(WR) < t_d(int)$ ]

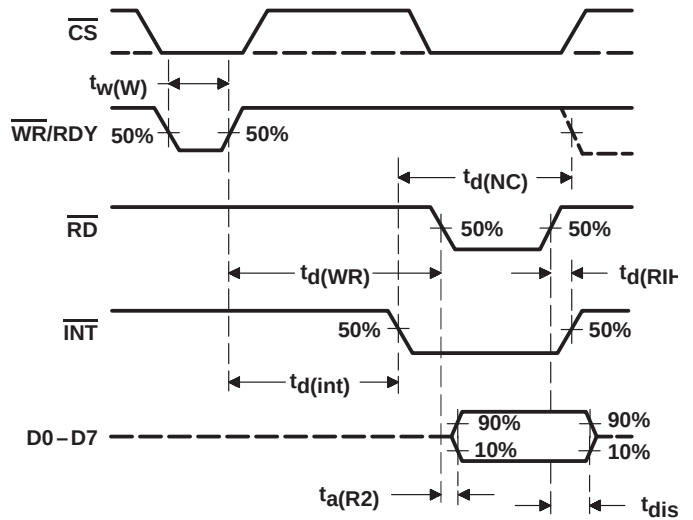


Figure 3. Write-Read-Mode Waveforms  
[MODE High and  $t_d(WR) > t_d(int)$ ]

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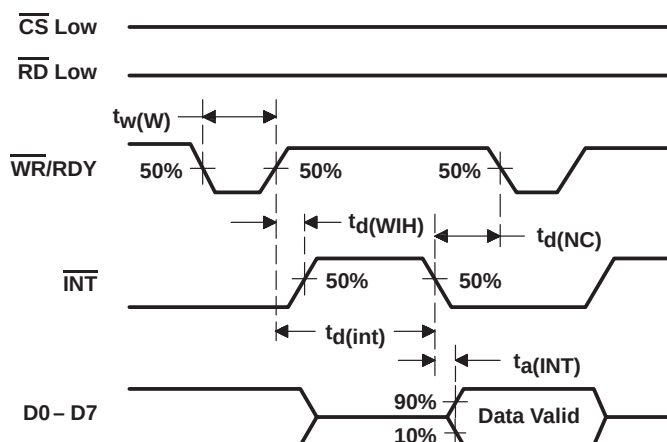
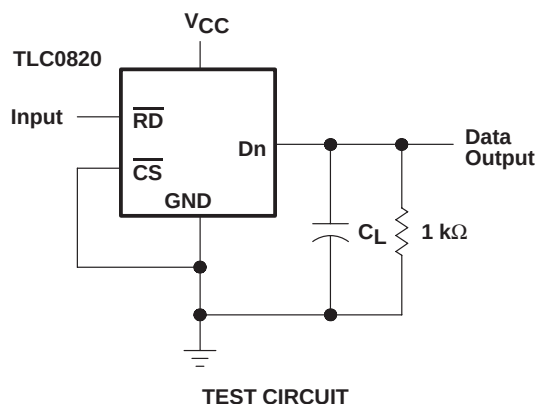
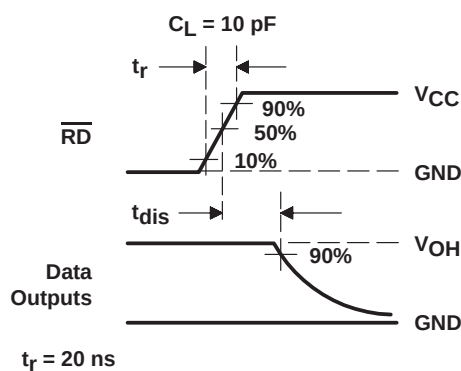


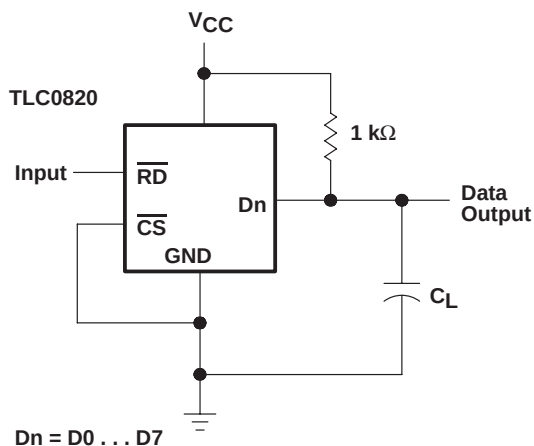
Figure 4. Write-Read-Mode Waveforms  
(Stand-Alone Operation, MODE High, and  $\overline{RD}$  Low)



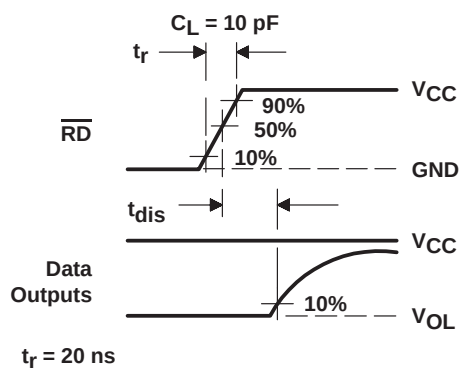
TEST CIRCUIT



VOLTAGE WAVEFORMS



TEST CIRCUIT



VOLTAGE WAVEFORMS

Figure 5. Test Circuit and Voltage Waveforms



## PRINCIPLES OF OPERATION

The TLC0820AC and TLC0820AI each employ a combination of sampled-data comparator techniques and flash techniques common to many high-speed converters. Two 4-bit flash analog-to-digital conversions are used to give a full 8-bit output.

The recommended analog input voltage range for conversion is  $-0.1\text{ V}$  to  $V_{CC} + 0.1\text{ V}$ . Analog input signals that are less than  $V_{ref-} + 1/2\text{ LSB}$  or greater than  $V_{ref+} - 1/2\text{ LSB}$  convert to 00000000 or 11111111, respectively. The reference inputs are fully differential with common-mode limits defined by the supply rails. The reference input values define the full-scale range of the analog input. This allows the gain of the ADC to be varied for ratiometric conversion by changing the  $V_{ref+}$  and  $V_{ref-}$  voltages.

The device operates in two modes, read (only) and write-read, that are selected by MODE. The converter is set to the read (only) mode when MODE is low. In the read mode,  $\overline{WR}/RDY$  is used as an output and is referred to as the ready terminal. In this mode, a low on  $\overline{WR}/RDY$  while  $\overline{CS}$  is low indicates that the device is busy. Conversion starts on the falling edge of  $\overline{RD}$  and is completed no more than  $2.5\text{ }\mu\text{s}$  later when  $\overline{INT}$  falls and  $\overline{WR}/RDY$  returns to the high-impedance state. Data outputs also change from high-impedance to active states at this time. After the data is read,  $\overline{RD}$  is taken high,  $\overline{INT}$  returns high, and the data outputs return to their high-impedance states.

When MODE is high, the converter is set to the write-read mode and  $\overline{WR}/RDY$  is referred to as the write terminal. Taking  $\overline{CS}$  and  $\overline{WR}/RDY$  low selects the converter and initiates measurement of the input signal. Approximately 600 ns after  $\overline{WR}/RDY$  returns high, the conversion is completed. Conversion starts on the rising edge of  $\overline{WR}/RDY$  in the write-read mode.

The high-order 4-bit flash ADC measures the input by means of 16 comparators operating simultaneously. A high-precision 4-bit DAC then generates a discrete analog voltage from the result of that conversion. After a time delay, a second bank of comparators does a low-order conversion on the analog difference between the input level and the high-order DAC output. The results from each of these conversions enter an 8-bit latch and are output to the 3-state output buffers on the falling edge of  $\overline{RD}$ .

# TLC0820AC, TLC0820AI

## Advanced LinCMOS™ HIGH-SPEED 8-BIT ANALOG-TO-DIGITAL CONVERTERS USING MODIFIED FLASH TECHNIQUES

SLAS064A – SEPTEMBER 1986 – REVISED JUNE 1994

### APPLICATION INFORMATION

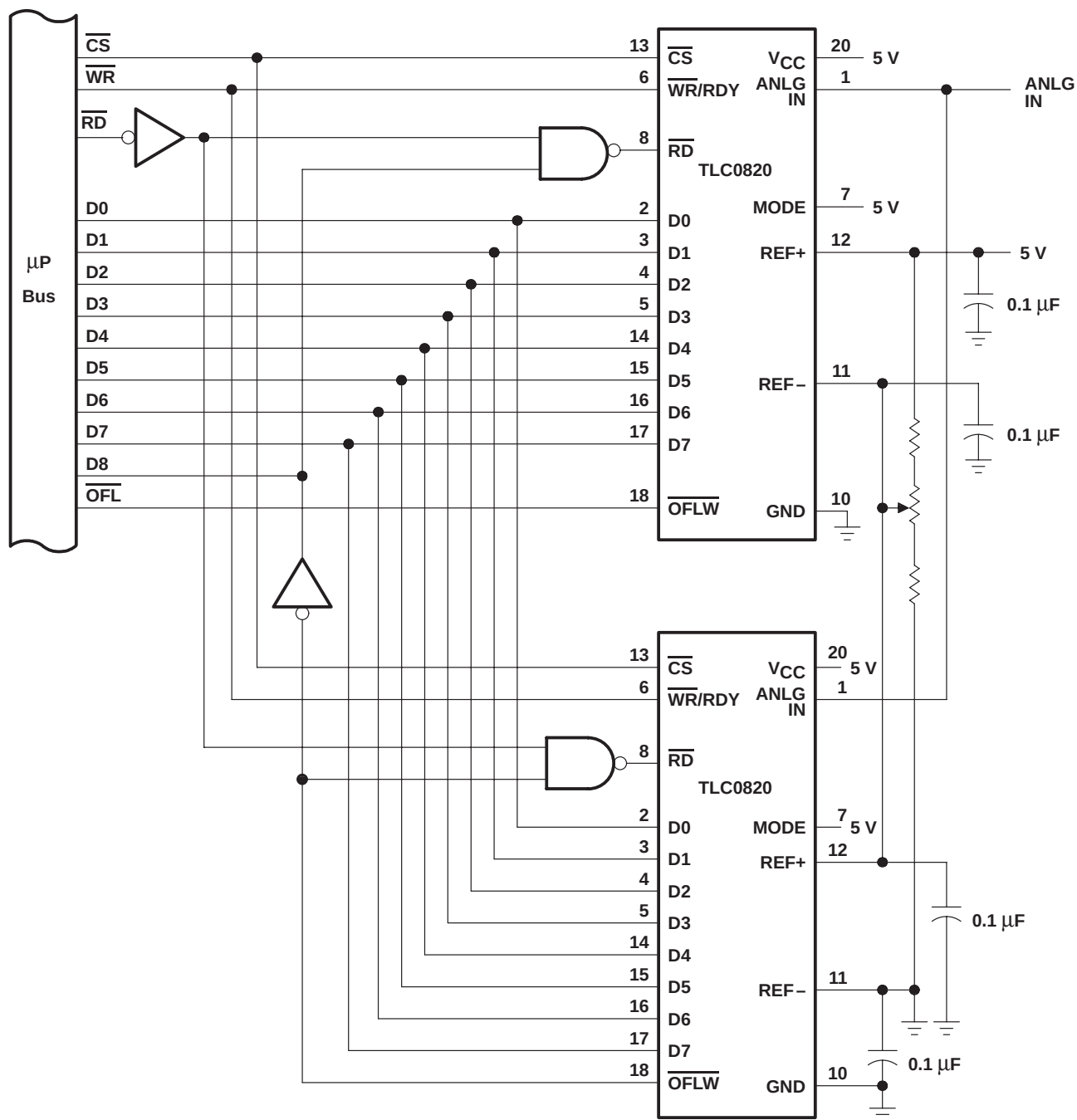


Figure 6. Configuration for 9-Bit Resolution

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)     | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TLC0820ACDB      | ACTIVE        | SSOP         | DB                 | 20   | 70             | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | P0820A                  | <a href="#">Samples</a> |
| TLC0820ACDBR     | ACTIVE        | SSOP         | DB                 | 20   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   |              | P0820A                  | <a href="#">Samples</a> |
| TLC0820ACDW      | ACTIVE        | SOIC         | DW                 | 20   | 25             | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   |              | TLC0820A                | <a href="#">Samples</a> |
| TLC0820ACDWR     | ACTIVE        | SOIC         | DW                 | 20   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   |              | TLC0820A                | <a href="#">Samples</a> |
| TLC0820ACFN      | LIFEBUY       | PLCC         | FN                 | 20   | 46             | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   |              | TLC0820AC               |                         |
| TLC0820ACN       | ACTIVE        | PDIP         | N                  | 20   | 20             | RoHS &<br>Non-Green | NIPDAU                               | N / A for Pkg Type   |              | TLC0820ACN              | <a href="#">Samples</a> |
| TLC0820AIDW      | ACTIVE        | SOIC         | DW                 | 20   | 25             | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   |              | TLC0820AI               | <a href="#">Samples</a> |
| TLC0820AIDWR     | ACTIVE        | SOIC         | DW                 | 20   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   |              | TLC0820AI               | <a href="#">Samples</a> |
| TLC0820AIFN      | LIFEBUY       | PLCC         | FN                 | 20   | 46             | RoHS & Green        | SN                                   | Level-1-260C-UNLIM   |              | TLC0820AI               |                         |
| TLC0820AIN       | ACTIVE        | PDIP         | N                  | 20   | 20             | RoHS &<br>Non-Green | NIPDAU                               | N / A for Pkg Type   |              | TLC0820AIN              | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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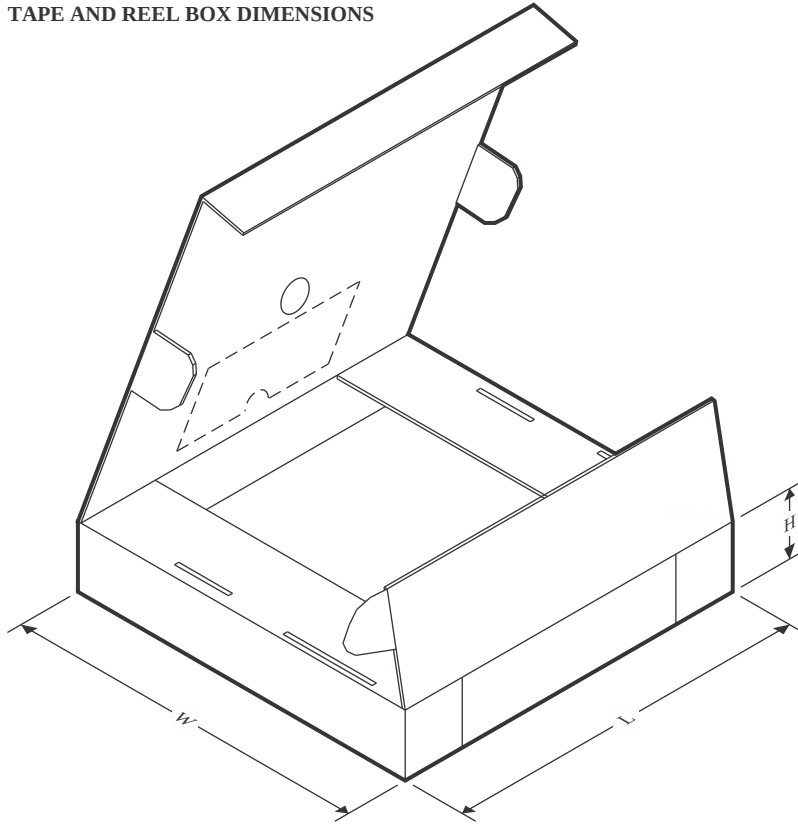
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

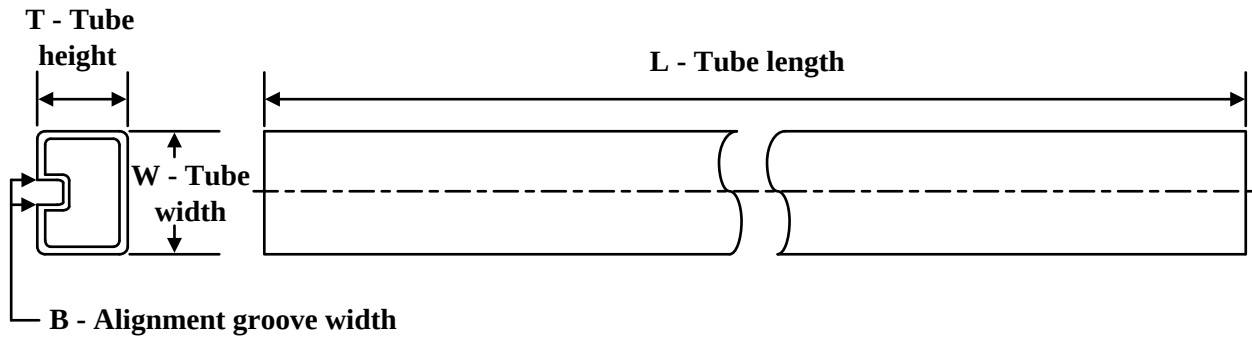
| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TLC0820ACDBR | SSOP         | DB              | 20   | 2000 | 330.0              | 16.4               | 8.2     | 7.5     | 2.5     | 12.0    | 16.0   | Q1            |
| TLC0820ACDWR | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |
| TLC0820AIDWR | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLC0820ACDBR | SSOP         | DB              | 20   | 2000 | 350.0       | 350.0      | 43.0        |
| TLC0820ACDWR | SOIC         | DW              | 20   | 2000 | 350.0       | 350.0      | 43.0        |
| TLC0820AIDWR | SOIC         | DW              | 20   | 2000 | 350.0       | 350.0      | 43.0        |

**TUBE**


\*All dimensions are nominal

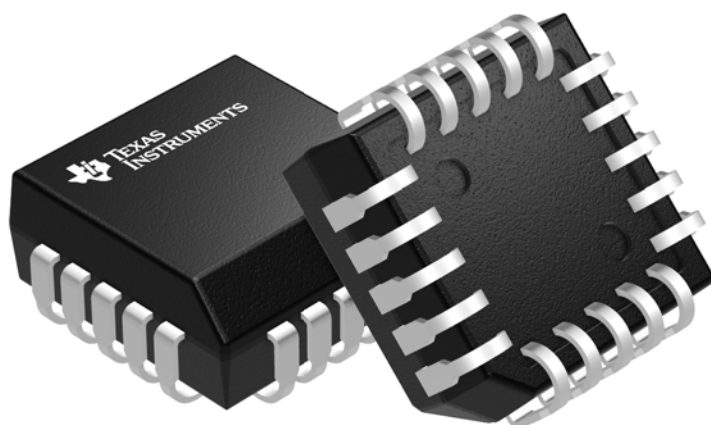
| Device      | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TLC0820ACDB | DB           | SSOP         | 20   | 70  | 530    | 10.5   | 4000   | 4.1    |
| TLC0820ACDW | DW           | SOIC         | 20   | 25  | 506.98 | 12.7   | 4826   | 6.6    |
| TLC0820ACFN | FN           | PLCC         | 20   | 46  | 497.33 | 10.69  | 5080   | 0      |
| TLC0820ACN  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| TLC0820AIDW | DW           | SOIC         | 20   | 25  | 506.98 | 12.7   | 4826   | 6.6    |
| TLC0820AIFN | FN           | PLCC         | 20   | 46  | 497.33 | 10.69  | 5080   | 0      |
| TLC0820AIN  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |

**FN 20**

## GENERIC PACKAGE VIEW

**PLCC - 4.57 mm max height**

PLASTIC CHIP CARRIER



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4040005-2/C

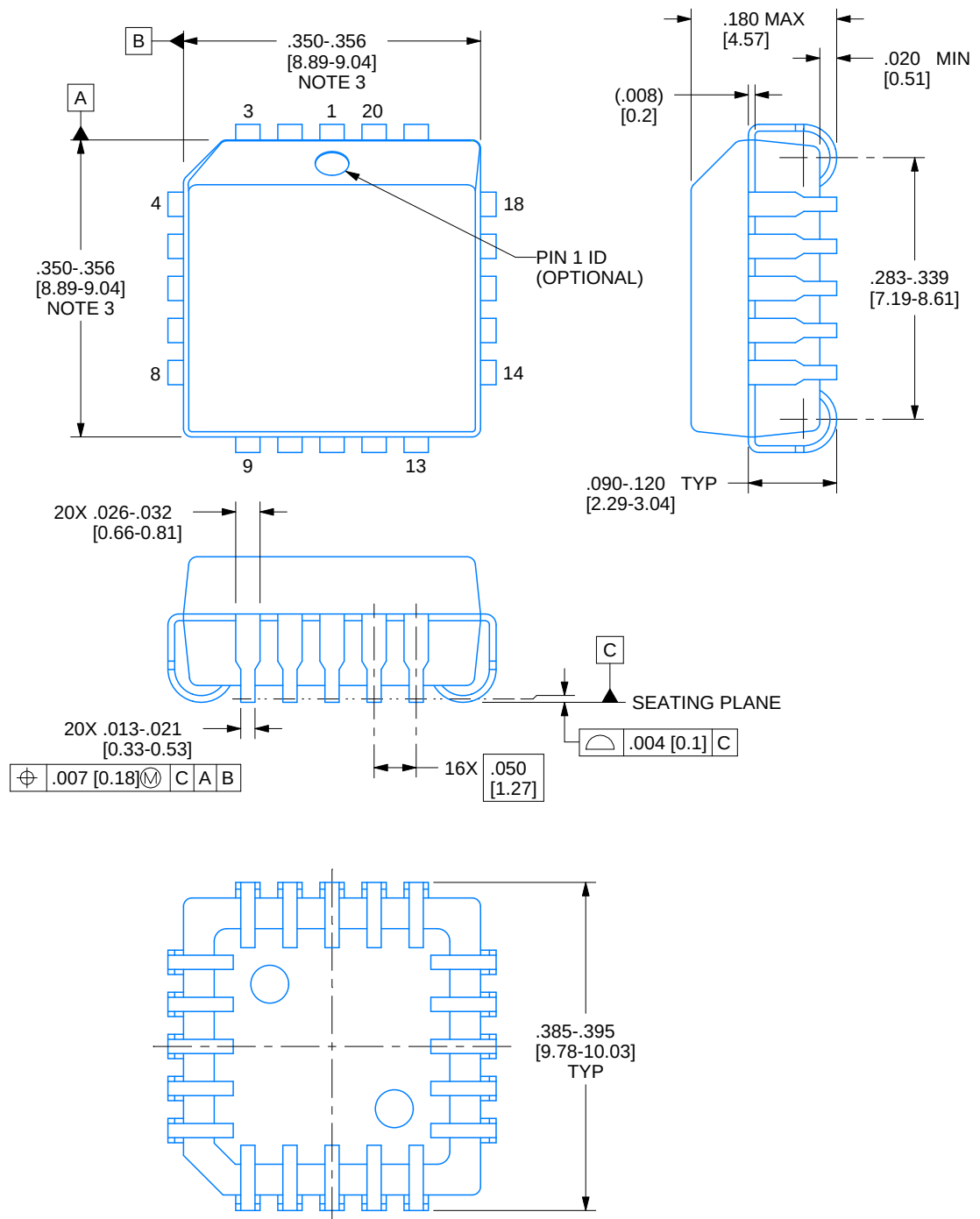


**FN0020A**

## PACKAGE OUTLINE

**PLCC - 4.57 mm max height**

## PLASTIC CHIP CARRIER



4215152/B 04/2017

NOTES:

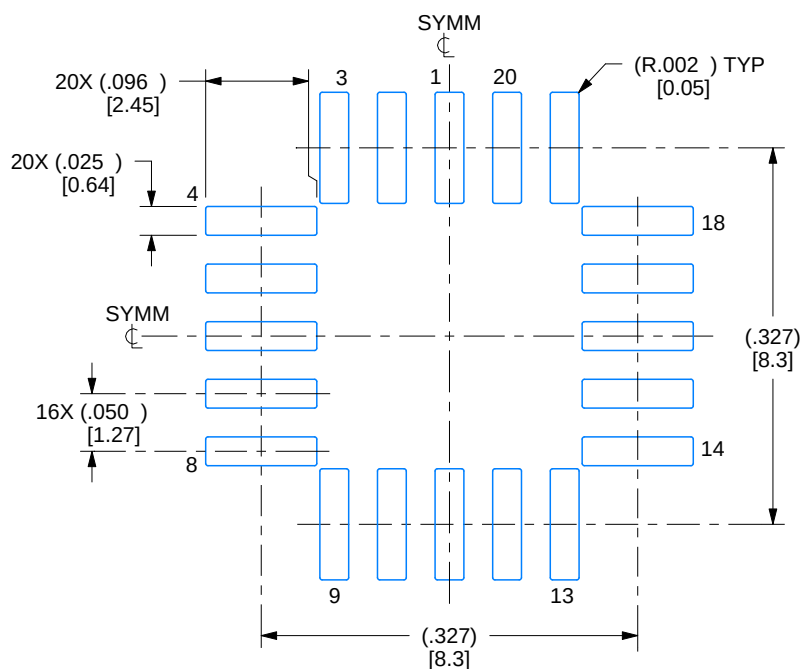
1. All linear dimensions are in inches. Any dimensions in brackets are in millimeters. Any dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Dimension does not include mold protrusion. Maximum allowable mold protrusion .01 in [0.25 mm] per side.
4. Reference JEDEC registration MS-018.

# EXAMPLE BOARD LAYOUT

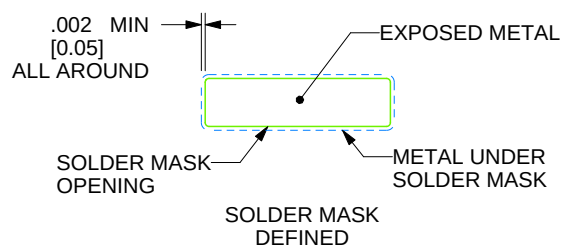
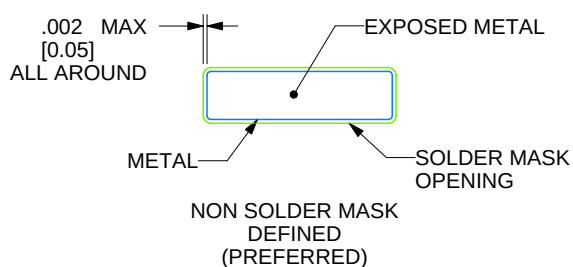
FN0020A

PLCC - 4.57 mm max height

PLASTIC CHIP CARRIER



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:6X



SOLDER MASK DETAILS

4215152/B 04/2017

NOTES: (continued)

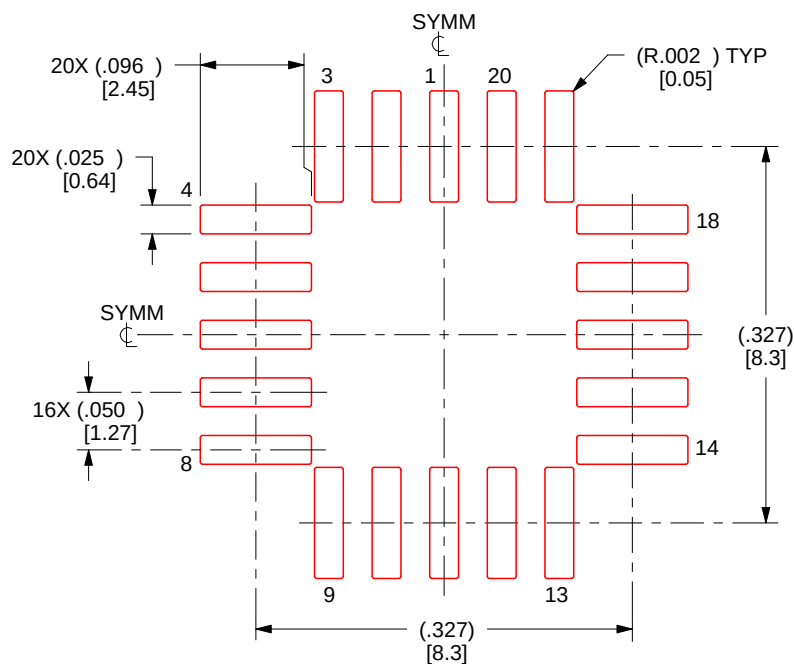
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

FN0020A

PLCC - 4.57 mm max height

PLASTIC CHIP CARRIER



**SOLDER PASTE EXAMPLE**  
 BASED ON 0.125 mm THICK STENCIL  
 SCALE:6X

4215152/B 04/2017

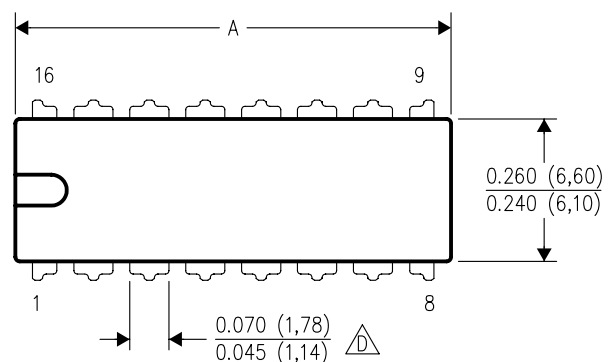
NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

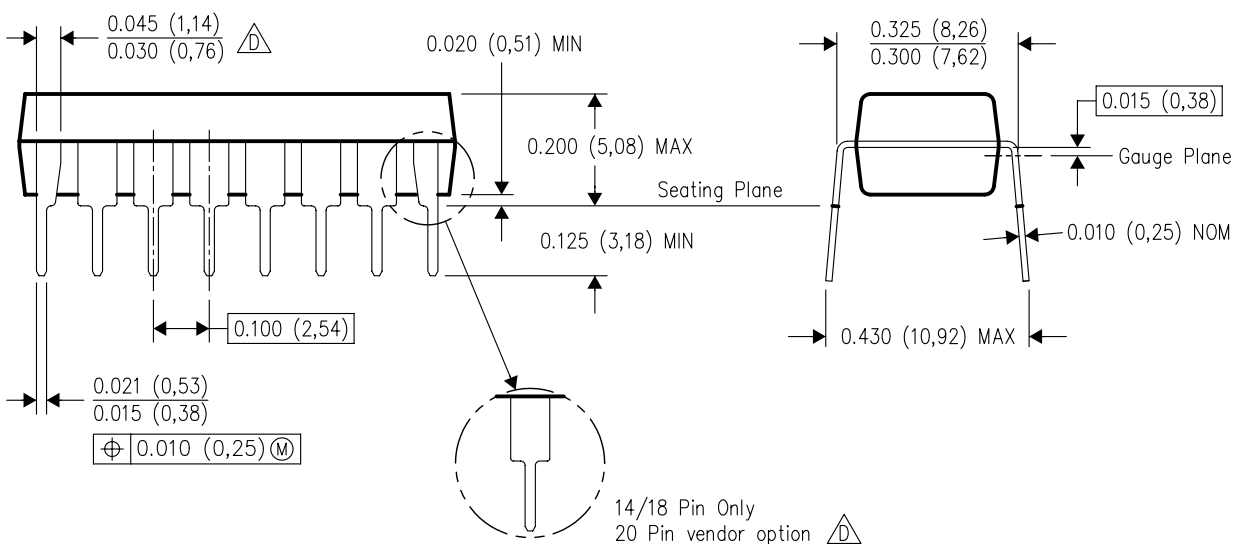
N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE

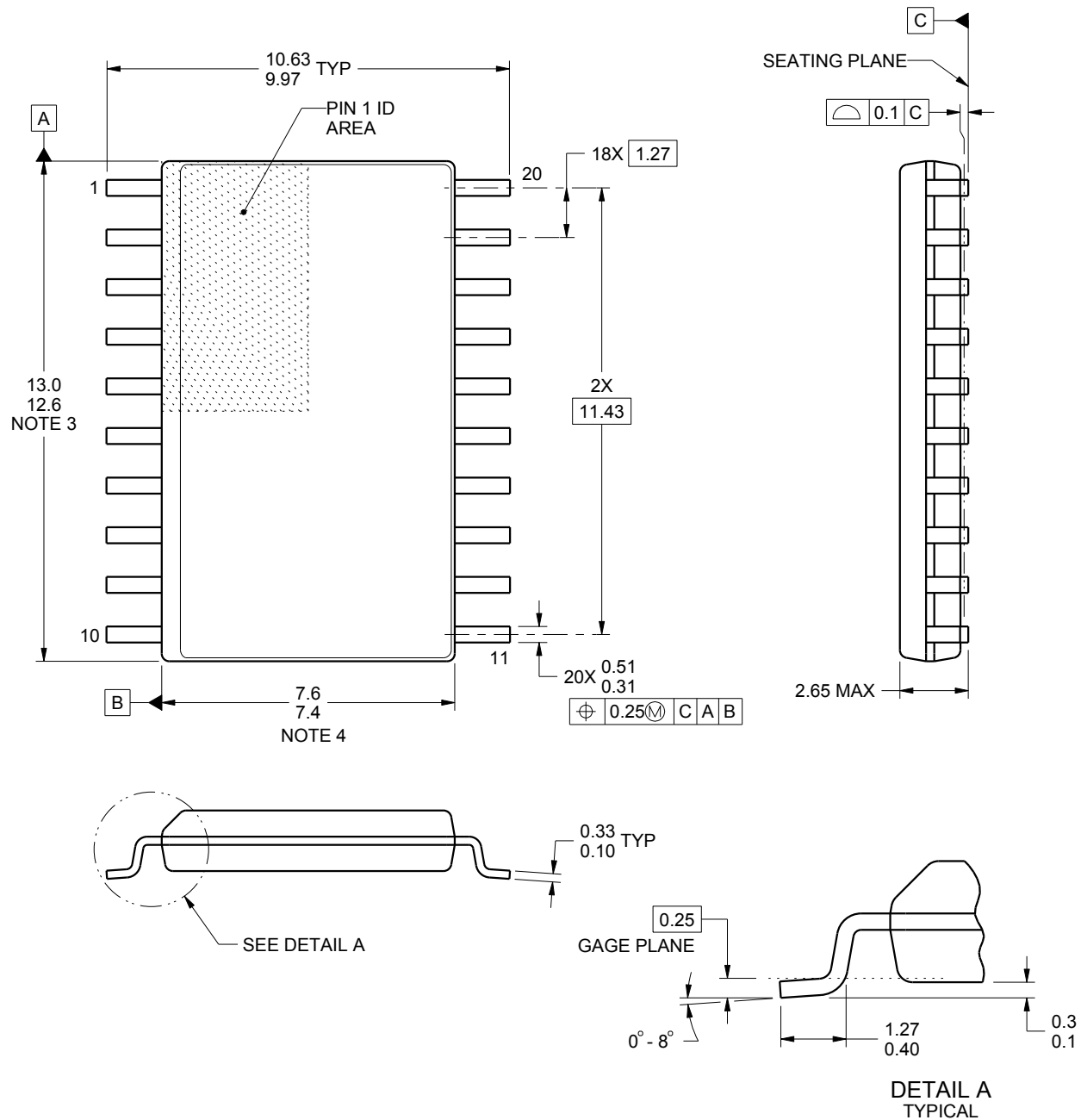
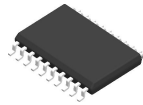


| PINS **<br>DIM      | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  -  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  -  The 20 pin end lead shoulder width is a vendor option, either half or full width.



4220724/A 05/2016

## NOTES:

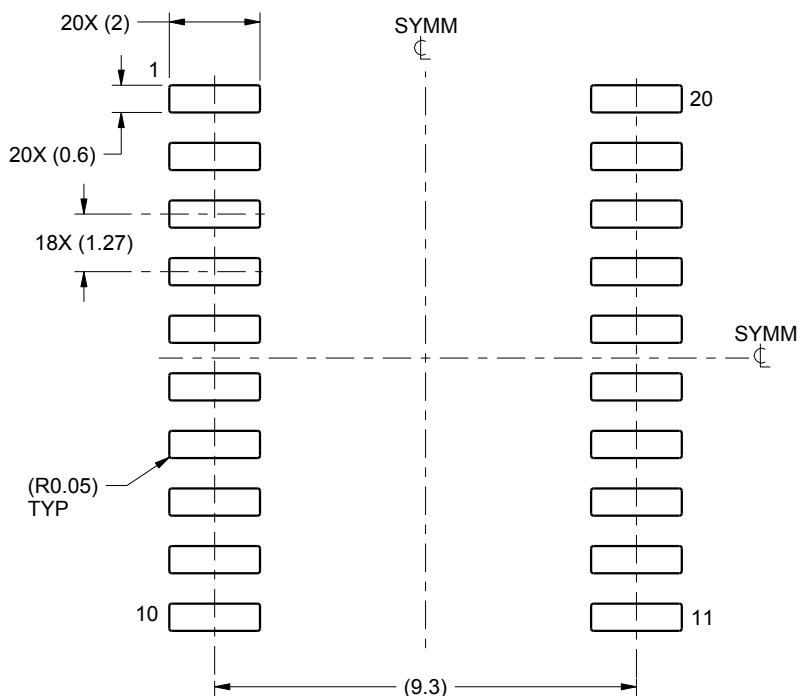
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

# EXAMPLE BOARD LAYOUT

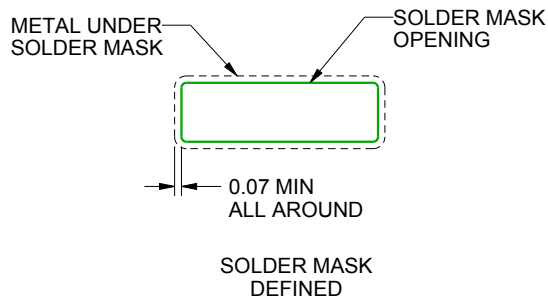
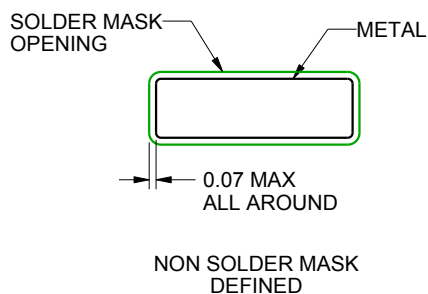
DW0020A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

4220724/A 05/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

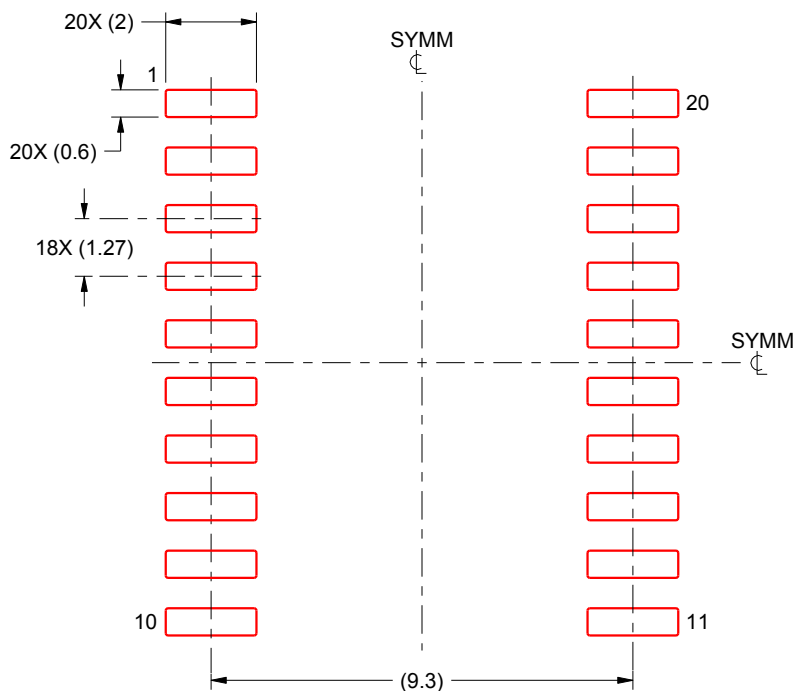
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

4220724/A 05/2016

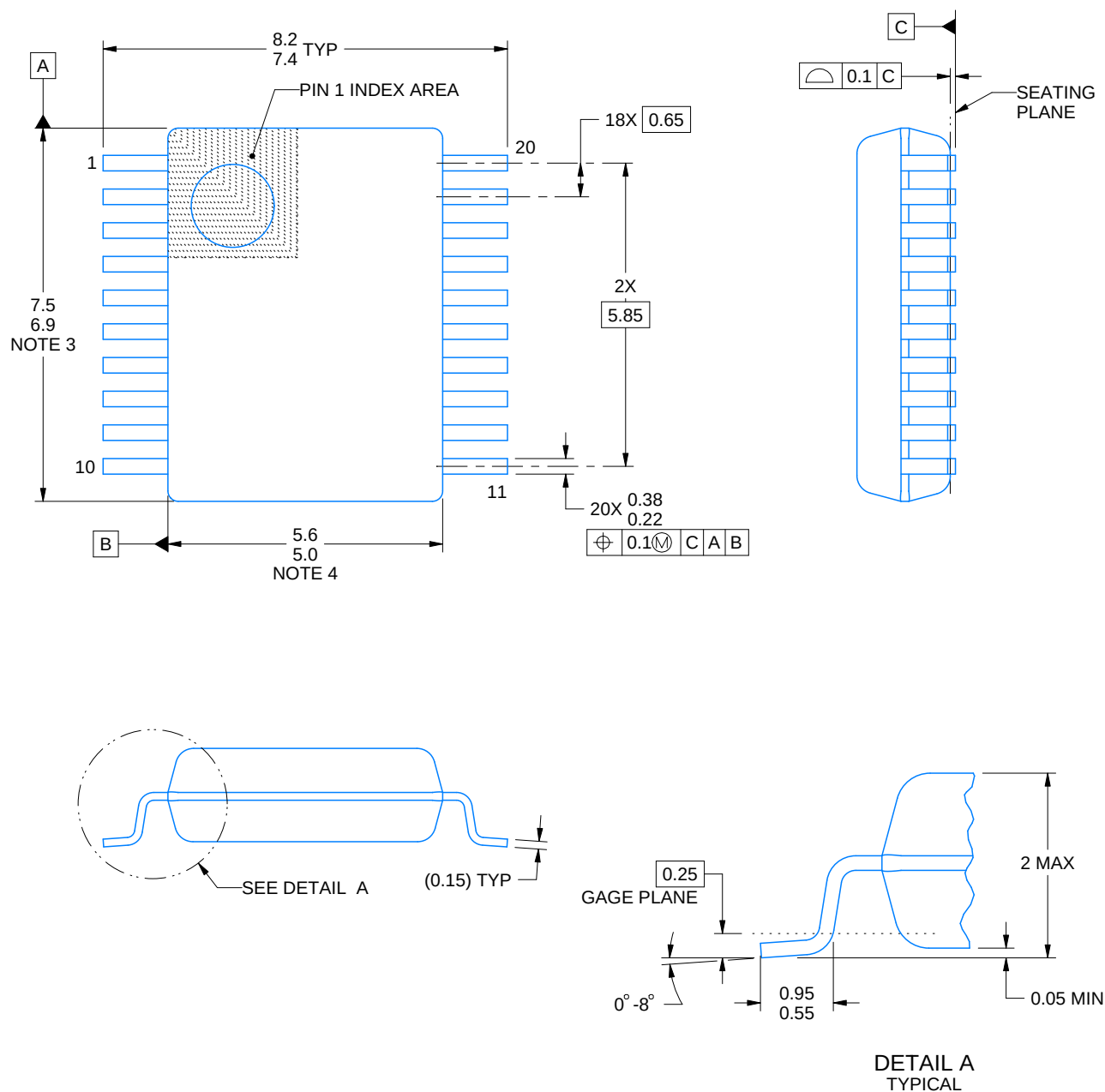
NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



**SSOP - 2 mm max height**

### SMALL OUTLINE PACKAGE



4214851/B 08/2019

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-150.

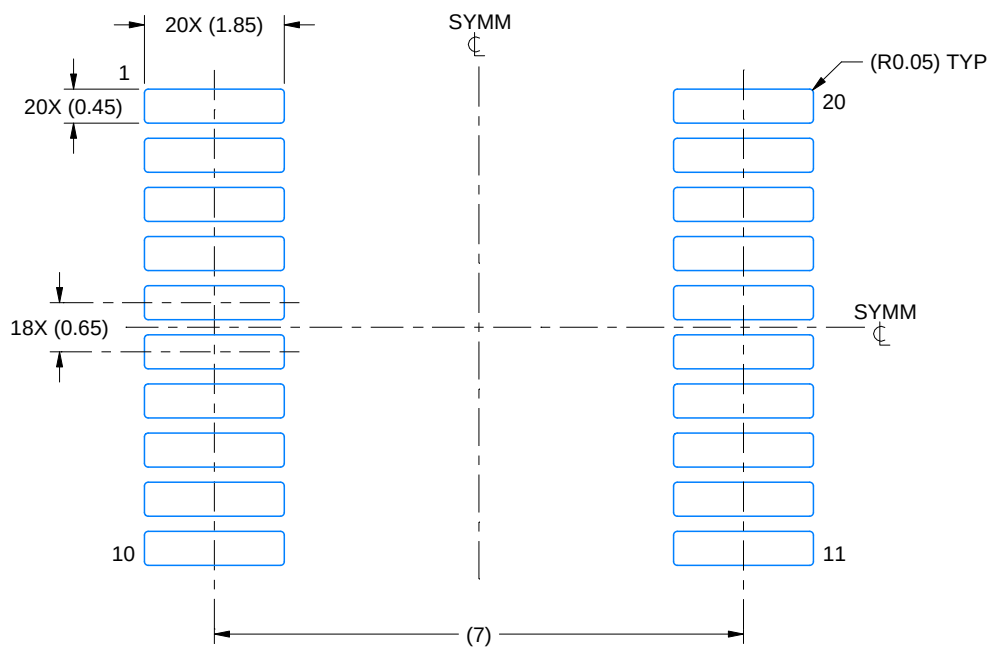


# EXAMPLE BOARD LAYOUT

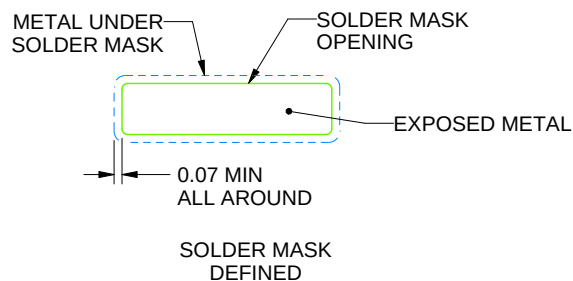
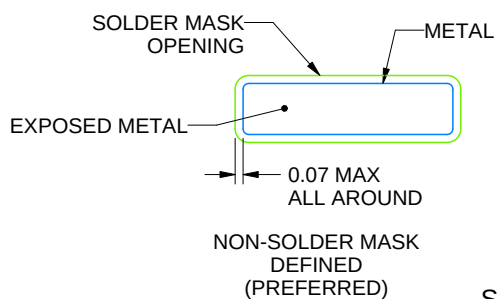
DB0020A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



SOLDER MASK DETAILS

4214851/B 08/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

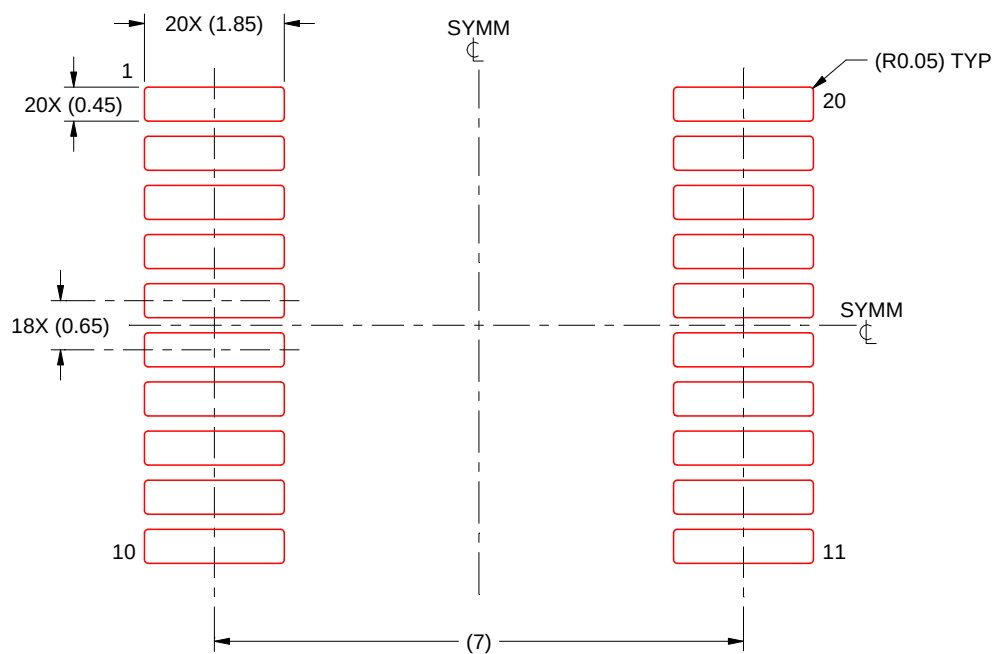
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DB0020A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4214851/B 08/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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